



(Solder side)

NOTE: Chip CLC114 (DIP) is placed in non standard way: on solder side without drilling holes

## Details:

CD4051B - ex Harris semiconductors, now it is Texas Instruments chip, <http://www.ti.com>  
8-to-1 mux

CLC114 - National semiconductors chip.  
<http://www.national.com>  
4 channel video buffer.

Discrete: 2x 1000 $\mu$ F, 16V; 2x 16 $\mu$ F, 10V, few 0.1 $\mu$ F,  
5x 75om, few diodes, 2x trim ~100om, etc.

PCB is double sided, one side is fully coated with copper and connected to ground line (GND), Cd4051 chip is connected to that side, all connections made on the "air"

